

Features

- Surface mount packaging for automated assembly
- Small footprint size (1206) and low profile for space-constrained mobile applications
- Ultra-low resistance
- RoHS compliant* and halogen free**
- Agency recognition: 🖼 us



MF-NSML Series - Low Ohmic PTC Resettable Fuses

Electrical Characteristics

	V max. Volts		l _{hold}	I _{trip}	Resis	tance	nce Max. Time To Trip		Tripped Power Dissipation
Model			Amperes at 23 °C		Ohms at 23 °C		Amperes at 23 °C	Seconds at 23 °C	Watts at 23 °C
			Hold	Trip	R _{Min.}	R _{1Max.}			Тур.
MF-NSML150	6	50	1.50	3.00	0.0100	0.0650	8.00	0.50	0.8
MF-NSML175	6	50	1.75	3.50	0.0050	0.0400	8.00	0.50	0.8
MF-NSML190	6	50	1.90	4.90	0.0050	0.0300	8.00	1.00	0.8
MF-NSML200	6	50	2.00	4.00	0.0050	0.0300	8.00	1.00	0.8
MF-NSML260	6	50	2.60	5.20	0.0030	0.0260	8.00	4.00	0.8
MF-NSML300	6	50	3.00	6.00	0.0025	0.0200	8.00	4.00	0.8
MF-NSML350	6	50	3.50	7.00	0.0020	0.0180	8.00	5.00	0.8
MF-NSML380	6	50	3.80	8.00	0.0015	0.0140	8.00	5.00	0.8
MF-NSML400	6	50	4.00	8.00	0.0015	0.0140	8.00	5.00	0.8
MF-NSML450	6	50	4.50	9.00	0.0010	0.0140	22.5	2.00	0.8
MF-NSML500	6	50	5.00	10.0	0.0010	0.0120	25.0	2.00	0.8
MF-NSML550	6	50	5.50	11.0	0.0010	0.0110	27.5	2.00	0.8
MF-NSML600	6	50	6.00	12.0	0.0010	0.0100	30.0	2.00	0.8

Environmental Characteristics

Operating Temperature	40 °C to +85 °C	
Storage Condition		
Before Opening	+40 °C max. / 70 % RH max.	
After Opening	+40 °C max. / 10 % RH max.	
Floor Condition After Opening	Consumption within 4 weeks at floor condition +	-30 °C max. / 60 % RH max.
Passive Aging	+85 °C, 1000 hours	±10 % typical resistance change
Humidity Aging	+85 °C, 85 % R.H. 100 hours	±15 % typical resistance change
Thermal Shock	+85 °C to -40 °C, 20 times	±30 % typical resistance change
Solvent Resistance	MIL-STD-202, Method 215	No change
	MIL-STD-883C, Method 2007.1,	
	Condition A	S .
Moisture Sensitivity Level (MSL)	See Note	
ESD Classification - HBM		

Test Procedures And Requirements

Test Test Conditions Visual/Mech. Verify dimensions and materials Resistance. In still air @ 23 °C. Time to Trip. At specified current, Vmax, 23 °C. Hold Current 30 min. at Ihold Trip Cycle Life. Vmax, Imax, 100 cycles. Trip Endurance Vmax, 48 hours Solderability 245 °C ± 5 °C, 5 seconds	Rmin ≤ R ≤ R1max T ≤ max. time to trip (seconds) No trip No arcing or burning No arcing or burning
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TÜV Certificate Number R 50302873



WARNING Cancer and Reproductive Harm - www.P65Warnings.ca.gov

Specifications are subject to change without notice.

^{*} RoHS Directive 2015/863, Mar 31, 2015 and Annex.
**Bourns considers a product to be "halogen free" if (a) the Bromine (Br) content is 900 ppm or less; (b) the Chlorine (CI) content is 900 ppm or less; and (c) the total Bromine (Br) and Chlorine (Cl) content is 1500 ppm or less.

Applications

- Thermal protection for Li-ion & polymer battery packs
- USB port protection USB 2.0, 3.0 & OTG
- HDMI 1.4 Source protection
- PC motherboards Plug & Play protection
- Mobile phones Battery & port protection
- PDAs / digital cameras
- Game console port protection

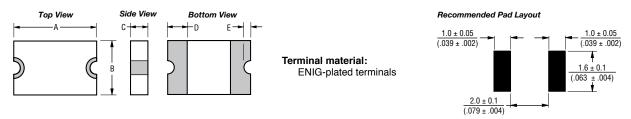
MF-NSML Series - Low Ohmic PTC Resettable Fuses

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Product Dimensions

Model	A		В		С		D	E	
Model	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Min.	Max.
MF-NSML150									
MF-NSML175									
MF-NSML190									
MF-NSML200									
MF-NSML260	3.00 (0.118)	3.50 (0.138)	1.40 (0.055)	1.80 (0.071)	0.30 (0.012)	<u>0.60</u> (0.024)	<u>0.25</u> (0.010)	0.05 (0.002)	<u>0.45</u> (0.018)
MF-NSML300	(0.110)	(0.100)	(0.000)	(0.071)	(0.012)	(0.024)	(0.010)	(0.002)	(0.010)
MF-NSML350									
MF-NSML380									
MF-NSML400									
MF-NSML450									
MF-NSML500	3.00	3.50	1.40	1.80	0.60	1.20	0.25	0.05	0.45
MF-NSML550	(0.118)	(0.138)	(0.055)	(0.071)	(0.024)	(0.047)	(0.010)	(0.002)	(0.018)
MF-NSML600									

DIMENSIONS: $\frac{MM}{(INCHES)}$



Packaging Specifications

MF-NSML150~MF-NSML400 = 5000 pcs. per reel MF-NSML450~MF-NSML500 = 3500 pcs. per reel MF-NSML550~MF-NSML600 = 3000 pcs. per reel

Thermal Derating Table - Ihold (Amps)

Model	Ambient Operating Temperature								
Model	-40 °C	-20 °C	0 °C	23 °C	40 °C	50 °C	60 °C	70 °C	85 °C
MF-NSML150	2.20	2.00	1.77	1.50	1.28	1.15	1.07	0.85	0.70
MF-NSML175	2.57	2.33	2.07	1.75	1.49	1.34	1.24	1.00	0.80
MF-NSML190	2.80	2.55	2.25	1.90	1.60	1.46	1.35	1.09	0.90
MF-NSML200	2.94	2.65	2.35	2.00	1.70	1.53	1.42	1.14	0.93
MF-NSML260	3.82	3.46	3.07	2.60	2.21	1.95	1.85	1.48	1.20
MF-NSML300	4.41	3.99	3.54	3.00	2.55	2.32	2.13	1.71	1.38
MF-NSML350	5.15	4.66	4.13	3.50	2.98	2.71	2.49	2.00	1.65
MF-NSML380	5.59	5.05	4.48	3.80	3.23	2.95	2.60	2.15	1.75
MF-NSML400	5.80	5.25	4.65	4.00	3.40	3.10	2.65	2.20	1.80
MF-NSML450	6.10	5.40	4.70	4.50	3.60	3.15	2.70	2.25	1.85
MF-NSML500	6.80	6.00	5.25	5.00	4.00	3.50	3.00	2.50	1.90
MF-NSML550	7.50	6.60	5.80	5.50	4.40	3.85	3.30	2.75	2.10
MF-NSML600	8.15	7.20	6.35	6.00	4.80	4.20	3.60	3.00	2.30

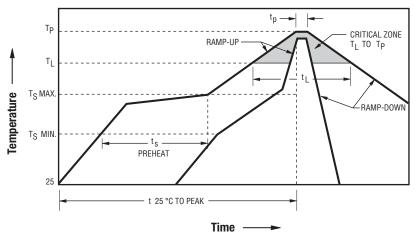
Specifications are subject to change without notice.

Users should verify actual device performance in their specific applications.

MF-NSML Series - Low Ohmic PTC Resettable Fuses

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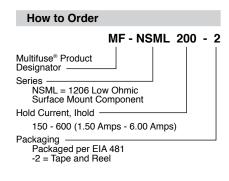
Solder Reflow Recommendations

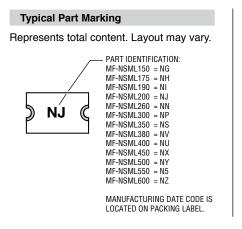


Notes:

- MF-NSML models cannot be wave soldered or hand soldered. Please contact Bourns for soldering recommendations.
- All temperatures refer to topside of the package, measured on the package body surface.
- If reflow temperatures exceed the recommended profile, devices may not meet the published specifications.
- · Compatible with Pb and Pb-free solder reflow profiles.
- Excess solder may cause a short circuit, especially during hand soldering. Please refer to the Multifuse® Polymer PTC Soldering Recommendation guidelines.

Profile Feature	Pb-Free Assembly				
Average Ramp-Up Rate (Ts _{max} to T _p)	3 °C / second max.				
PREHEAT:					
Temperature Min. (Ts _{min})	150 °C				
Temperature Max. (Ts _{max})	200 °C				
Time (Ts _{min} to Ts _{max}) (ts)	60~180 seconds				
TIME MAINTAINED ABOVE:					
Temperature (T _L)	217 °C				
Time (t _L)	60~150 seconds				
Peak Temperature (T _p)	260 °C				
Time within 5 °C of Actual Peak Temperature (tp)	20~40 seconds				
Ramp-Down Rate	6 °C / second max.				
Time 25 °C to Peak Temperature	8 minutes max.				





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Bourns® Multifuse® PPTC Resettable Fuses

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Application Notice

- Users are responsible for independent and adequate evaluation of Bourns® Multifuse® Polymer PTC devices in the user's application, including the PPTC device characteristics stated in the applicable data sheet.
- Polymer PTC devices must not be allowed to operate beyond their stated maximum ratings. Operation in excess of such
 maximum ratings could result in damage to the PTC device and possibly lead to electrical arcing and/or fire. Circuits with
 inductance may generate a voltage above the rated voltage of the polymer PTC device and should be thoroughly evaluated
 within the user's application during the PTC selection and qualification process.
- Polymer PTC devices are intended to protect against adverse effects of temporary overcurrent or overtemperature
 conditions up to rated limits and are not intended to serve as protective devices where overcurrent or overvoltage conditions
 are expected to be repetitive or prolonged.
- In normal operation, polymer PTC devices experience thermal expansion under fault conditions. Thus, a polymer PTC
 device must be protected against mechanical stress, and must be given adequate clearance within the user's application to
 accommodate such thermal expansion. Rigid potting materials or fixed housings or coverings that do not provide adequate
 clearance should be thoroughly examined and tested by the user, as they may result in the malfunction of polymer PTC
 devices if the thermal expansion is inhibited.
- Exposure to lubricants, silicon-based oils, solvents, gels, electrolytes, acids, and other related or similar materials may adversely affect the performance of polymer PTC devices.
- Aggressive solvents may adversely affect the performance of polymer PTC devices. Conformal coating, encapsulating, potting, molding, and sealing materials may contain aggressive solvents including but not limited to xylene and toluene, which are known to cause adverse effects on the performance of polymer PTCs. Such aggressive solvents must be thoroughly cured or baked to ensure their complete removal from polymer PTCs to minimize the possible adverse effect on the device.
- Recommended storage conditions should be followed at all times. Such conditions can be found on the applicable data sheet and on the Multifuse® Polymer PTC Moisture/Reflow Sensitivity Classification (MSL) note: https://www.bourns.com/docs/RoHS-MSL/msl_mf.pdf

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